

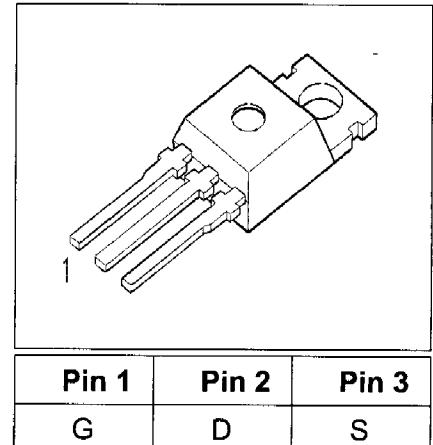
# New Jersey Semi-Conductor Products, Inc.

20 STERN AVE.  
SPRINGFIELD, NEW JERSEY 07081  
U.S.A.

TELEPHONE: (973) 376-2922  
(212) 227-6005  
FAX: (973) 376-8960

## BUZ 50 B

- N channel
- Enhancement mode

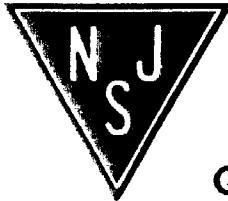


Type	$V_{DS}$	$I_D$	$R_{DS(on)}$	Package
BUZ 50 B	1000 V	2 A	8 Ω	TO-220 AB

### Maximum Ratings

Parameter	Symbol	Values	Unit
Drain source voltage	$V_{DS}$	1000	V
Drain-gate voltage $R_{GS} = 20 \text{ k}\Omega$	$V_{DGR}$	1000	
Continuous drain current $T_C = 25^\circ\text{C}$	$I_D$	2	A
Pulsed drain current $T_C = 25^\circ\text{C}$	$I_{Dpuls}$	8	
Gate source voltage	$V_{GS}$	$\pm 20$	V
Power dissipation $T_C = 25^\circ\text{C}$	$P_{tot}$	78	W
Operating temperature	$T_j$	-55 ... + 150	
Storage temperature	$T_{stg}$	-55 ... + 150	$^\circ\text{C}$
Thermal resistance, chip case	$R_{thJC}$	$\leq 1.6$	
Thermal resistance, chip to ambient	$R_{thJA}$	75	K/W
DIN humidity category, DIN 40 040		C	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.



## BUZ 50 B

---

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}, I_D = 0.25 \text{ mA}, T_j = 25^\circ\text{C}$	$V_{(\text{BR})\text{DSS}}$	1000	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}, I_D = 1 \text{ mA}$	$V_{GS(\text{th})}$	2.1	3	4	
Zero gate voltage drain current $V_{DS} = 1000 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25^\circ\text{C}$ $V_{DS} = 1000 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 125^\circ\text{C}$	$I_{DSS}$	-	20	250	$\mu\text{A}$
		-	100	1000	
Gate-source leakage current $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	$I_{GSS}$	-	10	100	nA
Drain-Source on-resistance $V_{GS} = 10 \text{ V}, I_D = 1.5 \text{ A}$	$R_{DS(\text{on})}$	-	6.5	8	$\Omega$

## BUZ 50 B

---

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### Dynamic Characteristics

Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}, I_D = 1.5 \text{ A}$	$g_{fs}$	0.7	1.5	-	S
Input capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{iss}$	-	1600	2100	pF
Output capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{oss}$	-	70	120	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{rss}$	-	30	55	
Turn-on delay time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(on)}$	-	30	45	ns
Rise time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$ $R_{GS} = 50 \Omega$	$t_r$	-	40	60	
Turn-off delay time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(off)}$	-	110	140	
Fall time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$ $R_{GS} = 50 \Omega$	$t_f$	-	60	80	

## BUZ 50 B

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### Reverse Diode

Inverse diode continuous forward current $T_C = 25^\circ\text{C}$	$I_S$	-	-	2	A
Inverse diode direct current,pulsed $T_C = 25^\circ\text{C}$	$I_{SM}$	-	-	8	
Inverse diode forward voltage $V_{GS} = 0 \text{ V}, I_F = 6 \text{ A}$	$V_{SD}$	-	1.05	1.3	V
Reverse recovery time $V_R = 100 \text{ V}, I_F=I_S, dI_F/dt = 100 \text{ A}/\mu\text{s}$	$t_{rr}$	-	2	-	$\mu\text{s}$
Reverse recovery charge $V_R = 100 \text{ V}, I_F=I_S, dI_F/dt = 100 \text{ A}/\mu\text{s}$	$Q_{rr}$	-	15	-	$\mu\text{C}$